

NOTE.

- ① Mounting side is mated with the receptacle:IT3M-300S-BGAC(**) and fixed with the latch.
Lot No. shall be marked on the indicated position.
- ③ The indicated mother board and daughter card shall be fastened to the additional reinforcements to prevent the stress on IT3*-300S-BGAC(**) solder joints.
- 4. Please refer to HIROSE document: ETAD-F0347 'IT3 design guideline'.
- 5. This product consists of 300 signal lines and 270 ground lines.
- 6. 30pcs of this products are packed in a soft tray.
- 7. Standard package of 30pcs are packaged in a carton box.

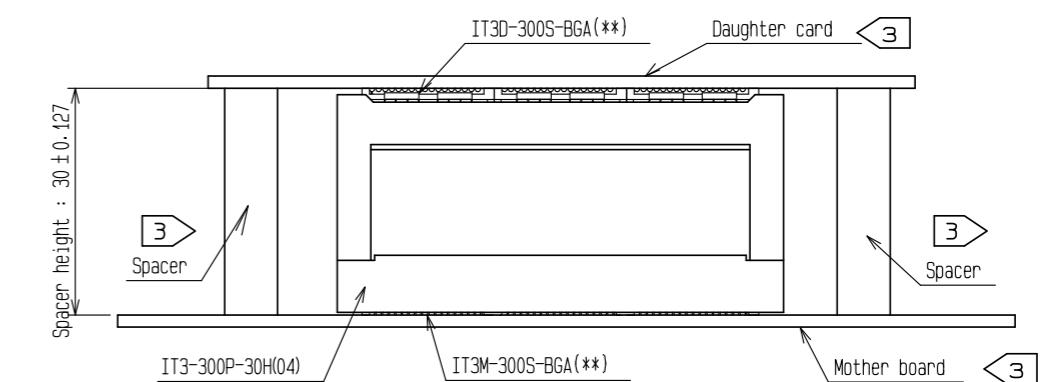
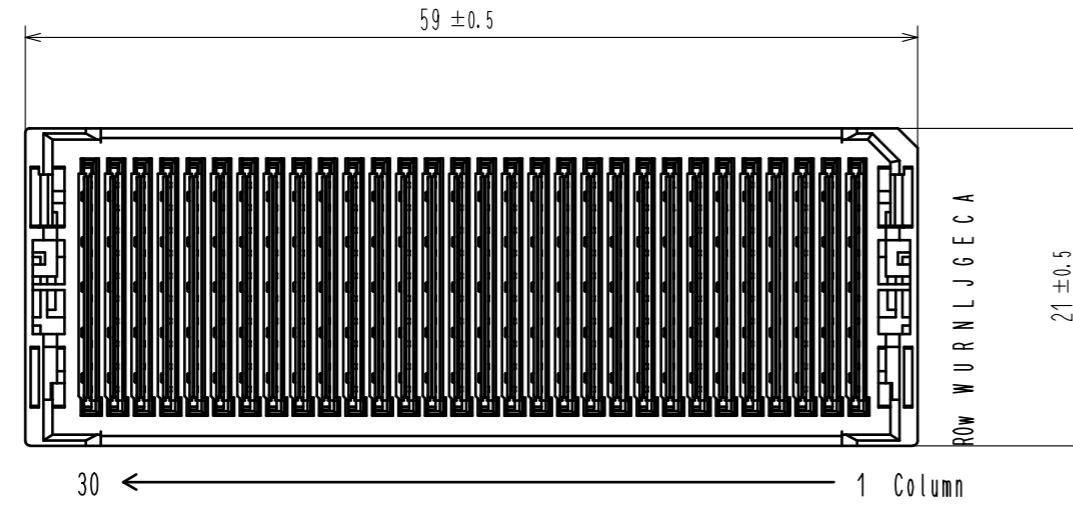
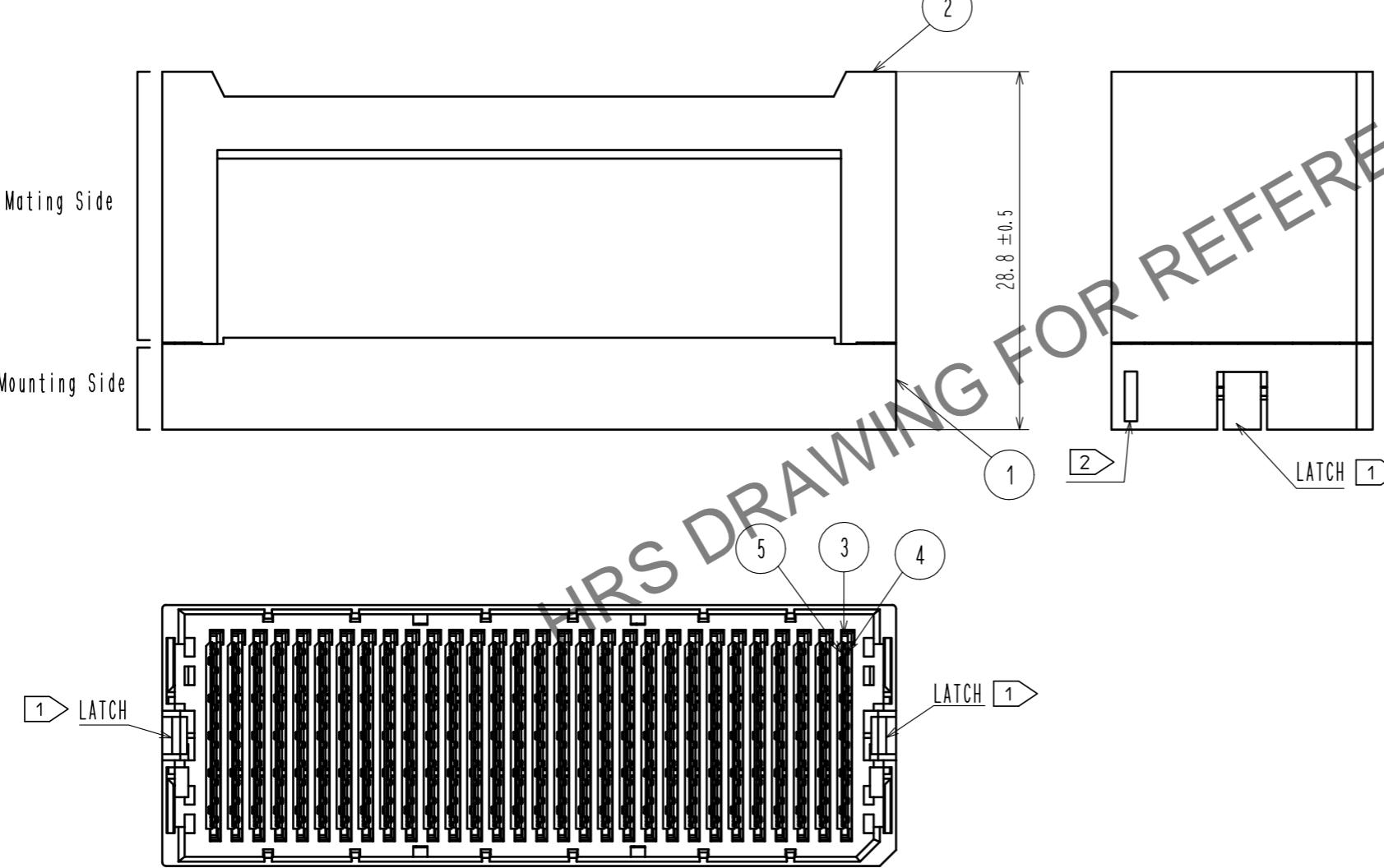
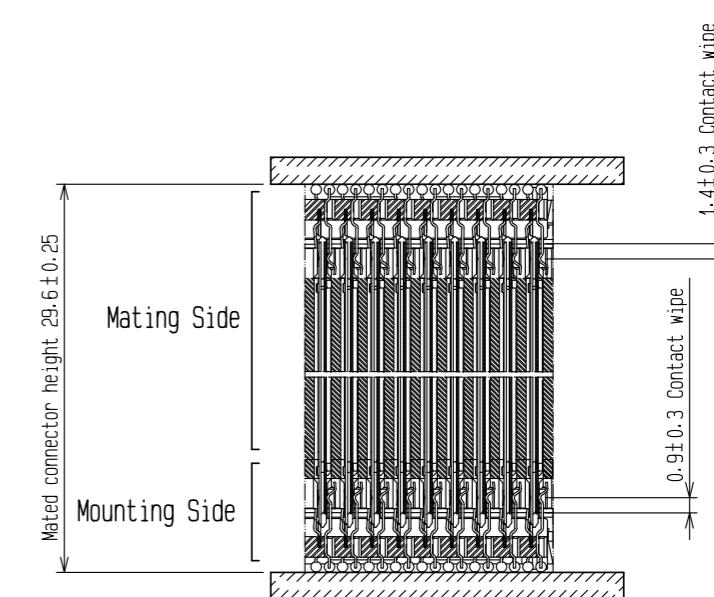


Fig. 1(FREE)



Mating Cross Section (Free)

NO.	MATERIAL	FINISH .	REMARKS	NO.	MATERIAL	FINISH .	REMARKS
3	LCP	BLACK	UL94V-0	5	Copper Alloy	CONTACT AREA:NICKEL(1.5 μ m)+GOLD (0.76 μ m)	
2	LCP	GRAY	UL94V-0	4	Copper Alloy	CONTACT AREA:NICKEL(1.5 μ m)+GOLD (0.76 μ m)	
1	PBT	BLACK	UL94V-0				
UNITS mm	SCALE 2 : 1	COUNT 10	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE	
			APPROVED :MK. EZAKI 15.08.26	DRAWING NO.	EDC-157706-04-00		
			CHECKED :MK. EZAKI 15.08.26	PART NO.	IT3-300P-30H(04)		
			DESIGNED :TF. SUGAWARA 15.08.26	CODE NO.	CL636-0185-7-04		
			DRAWN :KT. AIZAWA 15.08.26				

HRS
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